COMPLIANT

HALOGEN

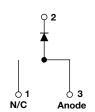
FREE



Vishay High Power Products

HEXFRED® Ultrafast Soft Recovery Diode, 4 A





PRODUCT SUMMARY					
V_{R}	600 V				
V _F at 4 A at 25 °C	1.8 V				
I _{F(AV)}	4 A				
t _{rr} (typical)	17 ns				
T _J (maximum)	150 °C				
Q _{rr} at 125 °C	40 nC				
dl _{(rec)M} /dt at 125 °C	280 A/μs				

FEATURES

- Ultrafast recovery
- Ultrasoft recovery
- Very low I_{RRM}
- Very low Q_{rr}
- Specified at operating temperature
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS directive 2002/95/EC
- AEC-Q101 qualified

BENEFITS

- · Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- · Reduced parts count

DESCRIPTION

VS-HFA04TB60S is a state of the art ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 4 A continuous current, the VS-HFA04TB60S is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA04TB60S is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V _R		600	V	
Maximum continuous forward current	I _F	T _C = 100 °C	4		
Single pulse forward current	I _{FSM}		25	Α	
Maximum repetitive forward current	I _{FRM}		16		
Maximum power dissipation	P_{D}	T _C = 25 °C	25	W	
Maximum power dissipation		T _C = 100 °C	10]	
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C	

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VS-HFA04TB60SPbF

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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V_{BR}	Ι _R = 100 μΑ		600	-	-	
		I _F = 4.0 A		-	1.5	1.8	V
Maximum forward voltage V _{FM}	V_{FM}	I _F = 8.0 A	See fig. 1	-	1.8	2.2	
		I _F = 4.0 A, T _J = 125 °C		-	1.4	1.7	
Maximum reverse		V _R = V _R rated	See fig. 2	-	0.17	3.0	μA
leakage current	I _{RM}	$T_J = 125$ °C, $V_R = 0.8 \times V_R$ rated	See lig. 2	-	44	300	μΑ
Junction capacitance	C _T	V _R = 200 V	See fig. 3	-	4.0	8.0	pF
Series inductance	L _S	Measured lead to lead 5 mm from package body - 8.0 -		nH			

DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
	t _{rr}	$I_F = 1.0 \text{ A}, dI_F/dt = 200 \text{ A}$	Vμs, V _R = 30 V	-	17	1	ns
Reverse recovery time See fig. 5, 6	t _{rr1}	T _J = 25 °C		-	28	42	
occ lig. 0, 0	t _{rr2}	T _J = 125 °C		-	38	57	
Peak recovery current	I _{RRM1}	T _J = 25 °C	$I_F = 4.0 \text{ A}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$ $V_R = 200 \text{ V}$	-	2.9	5.2	А
	I _{RRM2}	T _J = 125 °C		-	3.7	6.7	
Reverse recovery charge See fig. 7	Q _{rr1}	T _J = 25 °C		-	40	60	nC
	Q _{rr2}	T _J = 125 °C		-	70	105	iiC
Peak rate of fall of recovery current during t _b See fig. 8	dI _{(rec)M} /dt1	T _J = 25 °C		_	280	-	- A/μs
	dI _{(rec)M} /dt2	T _J = 125 °C		-	235	-	Αν μδ

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C
Thermal resistance, junction to case	R _{thJC}		-	-	5.0	K/W
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	80	- N/VV
Woight			-	2.0	-	g
Weight			-	0.07	-	oz.
Marking device		Case style D ² PAK		HFA04	TB60S	

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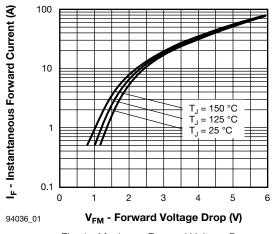


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

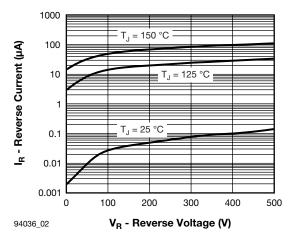


Fig. 2 - Typical Reverse Current vs. Reverse Voltage

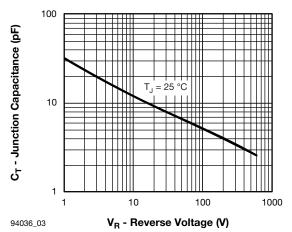


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

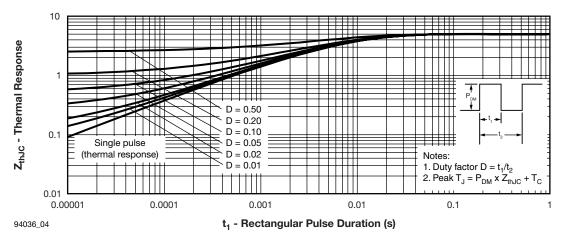


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

VS-HFA04TB60SPbF

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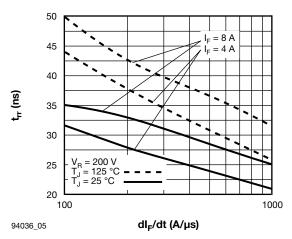


Fig. 5 - Typical Reverse Recovery Time vs. dI_F/dt

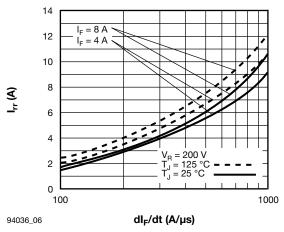


Fig. 6 - Typical Recovery Current vs. dl_F/dt

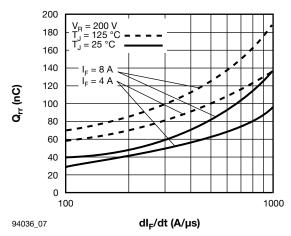


Fig. 7 - Typical Stored Charge vs. dl_F/dt

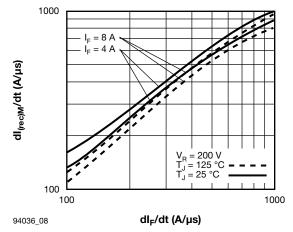


Fig. 8 - Typical $dI_{(rec)M}/dt$ vs. dI_F/dt

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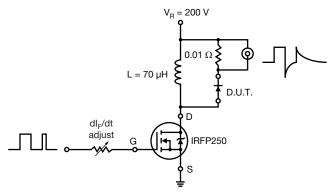
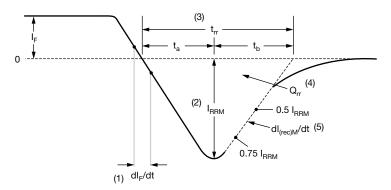


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dl_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) $t_{\rm rr}$ reverse recovery time measured from zero crossing point of negative going $I_{\rm F}$ to point where a line passing through 0.75 $I_{\rm RRM}$ and 0.50 $I_{\rm RRM}$ extrapolated to zero current.
- (4) \mathbf{Q}_{rr} area under curve defined by \mathbf{t}_{rr} and \mathbf{I}_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Fig. 10 - Reverse Recovery Waveform and Definitions

VS-HFA04TB60SPbF

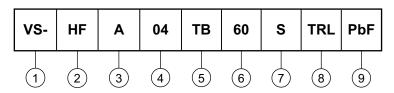
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ORDERING INFORMATION TABLE

Device code



- 1 HPP product suffix
- 2 HEXFRED® family
- **3** Process designator: A = Electron irradiated
- Current rating (04 = 4 A)
- Fackage outline (TB = TO-220, 2 leads)
- 6 Voltage rating (60 = 600 V)
- $7 S = D^2PAK$
- None = Tube (50 pieces)
 - TRL = Tape and reel (left oriented)
 - TRR = Tape and reel (right oriented)
- 9 PbF = Lead (Pb)-free

LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?95046</u>				
Part marking information <u>www.vishay.com/doc?95054</u>				
Packaging information	www.vishay.com/doc?95032			

For technical questions, contact: diodestech@vishay.com

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